

**KEMET Part Number: C2225C822J5GALTU**  
(C2225C822J5GAL7800)



SMD Comm COG SnPb, Ceramic, 8200 pF, 5%, 50 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 2225



Dimensions	
Chip Size	2225
L	5.6mm +/-0.4mm
W	6.4mm +/-0.4mm
T	1.4mm +/-0.15mm
B	0.6mm +/-0.35mm

Packaging Specifications	
Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	1000

General Information	
Series:	SMD Comm COG SnPb
Style:	SMD Chip
Description:	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features:	Ultra-Stable, Low Loss, Class I
RoHS:	No
Prop 65:	<b>WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">www.p65warnings.ca.gov</a> .
SCIP Number:	5549986b-60cf-4a2a-afbb-4ad1d7a11dcb
Termination:	Lead (SnPb)
Marking:	No
AEC-Q200:	No
Component Weight:	300 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	8200 pF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	5%
Voltage DC:	50 VDC
Dielectric Withstanding Voltage:	125 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.1% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	100 GOhms

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